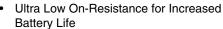


P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
- 20	0.0108 at V _{GS} = - 4.5 V	- 15.3		
	0.015 at V _{GS} = - 2.5 V	- 13.0		
	0.020 at V _{GS} = - 1.8 V	- 11.2		

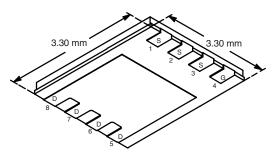
FEATURES

- Halogen-free Option Available
- TrenchFET® Power MOSFETS: 1.8 V Rated



- New PowerPAK® Package
 - Low Thermal Resistance, RthJC
 - Low 1.07 mm Profile

PowerPAK 1212-8



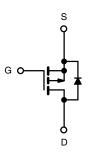
Bottom View

Ordering Information: Si7107DN-T1-E3 (Lead (Pb)-free)

Si7107DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

· Load/Power Switching In Portable Devices



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted							
Parameter		Symbol	10 s	Steady State	Unit		
Drain-Source Voltage		V _{DS}	- 20		V		
Gate-Source Voltage		V _{GS}	± 8				
Continuous Drain Current /T 150 °C\8	T _A = 25 °C	- I _D	- 15.3	- 9.8			
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		- 12.2	- 7.8	٨		
Pulsed Drain Current		I _{DM}	- 40		Α		
Continuous Source Current (Diode Conduction) ^a		I _S	- 3.2	- 1.3			
	T _A = 25 °C	- P _D	3.8	1.5	W		
Maximum Power Dissipation ^a	T _A = 70 °C		2.0	0.8			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C		
Soldering Recommendations (Peak Temperature) ^{b, c}			260				

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manifestore Longiting to Application	t ≤ 10 s	- R _{thJA}	24	33	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		65	81		
Maximum Junction-to-Case	Steady State	R _{thJC}	1.9	2.4		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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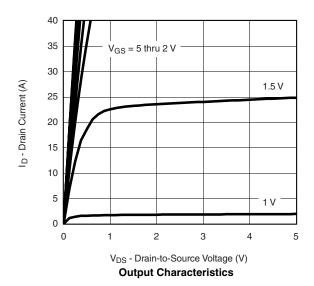
SPECIFICATIONS $T_J = 25 ^{\circ}\text{C}$ Parameter	Symbol	Test Conditions Mi		Тур.	Max.	Unit	
Static	<u>'</u>			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -450 \mu\text{A}$			- 1.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$	V _{DS} = - 20 V, V _{GS} = 0 V		- 1		
		V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 55 °C			- 5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 40			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 15.3 A		0.0090	0.0108		
		V _{GS} = - 2.5 V, I _D = - 13 A		0.0125	0.015	Ω	
		V _{GS} = - 1.8 V, I _D = - 5 A		0.0167	0.020		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 15.3 A		58		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 3.2 A, V _{GS} = 0 V		- 0.7	- 1.2	V	
Dynamic ^b							
Total Gate Charge	Q_g			34	44		
Gate-Source Charge	Q_{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -15.3 \text{ A}$		4.6		nC	
Gate-Drain Charge	Q_{gd}			9.2			
Gate Resistance	R_g	f = 1 MHz		8		Ω	
Turn-On Delay Time	t _{d(on)}			27	40		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		55	85	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_g = 6 Ω		270	400		
Fall Time	t _f			160	240		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 3.2 A, di/dt = 100 A/μs		110	165		

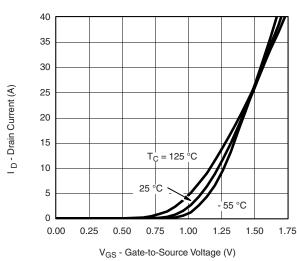
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





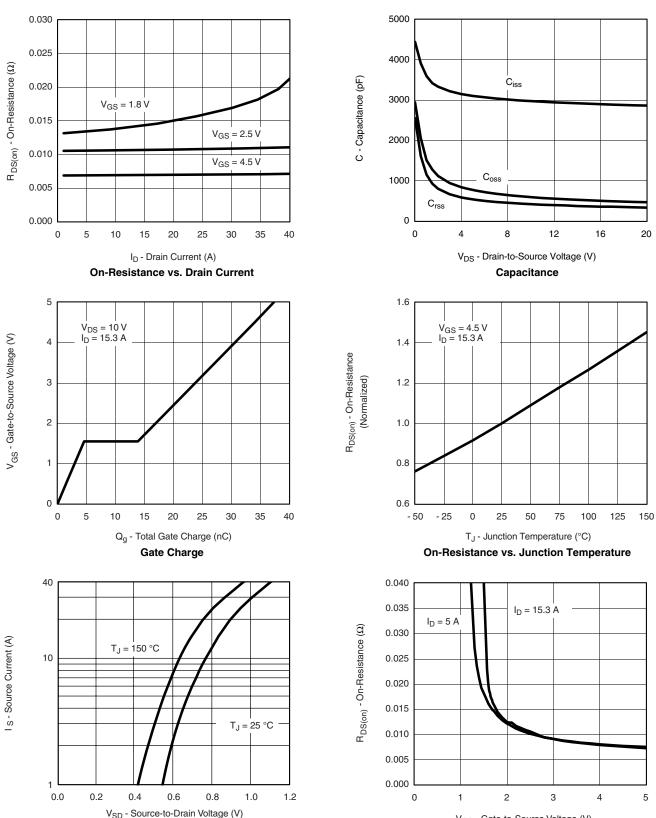
Transfer Characteristics







TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Source-Drain Diode Forward Voltage

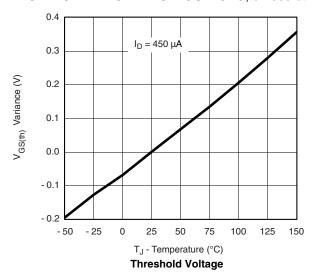
V_{GS} - Gate-to-Source Voltage (V)

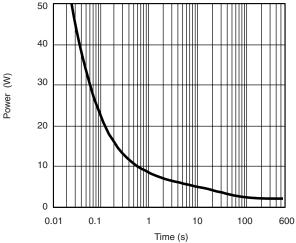
On-Resistance vs. Gate-to-Source Voltage

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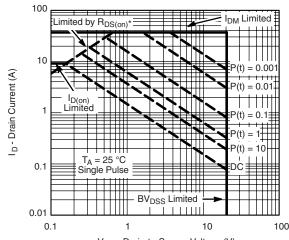
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



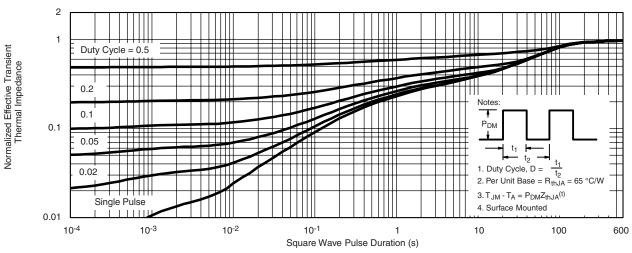


Single Pulse Power, Junction-to-Ambient



 $$V_{DS}$$ - Drain-to-Source Voltage (V) $$^*V_{GS}$$ > minimum V_{GS} at which $R_{DS(on)}$ is specified

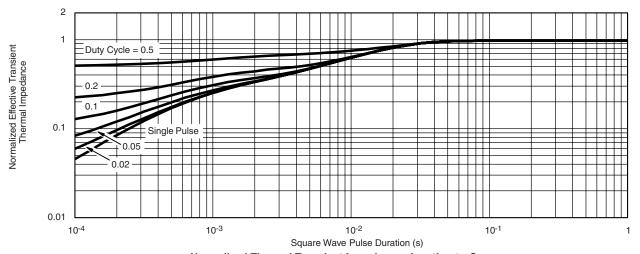
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73041.



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Revision: 18-Jul-08

Document Number: 91000 www.vishay.com